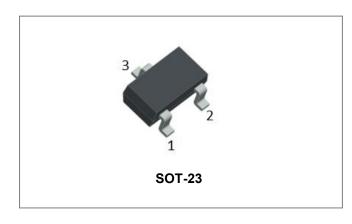




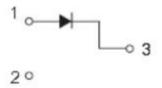
BZX84C2V4-BZX84C51 ZENER DIODE



Features

- Planar Die Construction
- 350mW Power Dissipation
- 2.4V- 51V Nominal Zener Voltage
- 5% Standard Vz Tolerance
- Designed for Surface Mount Application
- Plastic Material UL Recognition Flammability Classification 94V-O
- "-A" is an AEC-Q101 qualified device
- This is a Halogen Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Schematic & Pin Configuration



Mechanical Characteristics

- Case: SOT-23, Molded Plastic
- Terminals: Plated leads Solderable per MIL-STD-750,
 Mathead 2000.

Method 2026

• Mounting Position: Any

Weight: 0.008g

Maximum Ratings@TA=25°C unless otherwise specified

Parameter	Symbol	Value	Units
Power Dissipation	P _D	350	mW
Typical Thermal Resistance, Junction to Ambient	R _{θJA}	357	°C/W
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 to 150	°C





Electrical Characteristics @T_A=25°C unless otherwise specified

Part Number	Marking	Nominal Zener Voltage		Max. Zener Impedance			Max.Reverse Leakage Current			
		V	z(V) @ Izt	'1	Zzt @ lzt Zzk @ lzk		IR @ VR			
	35	Nom.	Min.	Max.	Ohm	mA	Ohm	mA	μA	V
BZX84C2V4	W1/Z11	2.4	2.28	2.52	100	5	600	1	50	1.0
BZX84C2V7	W2/Z12	2.7	2.5	2.9	100	5	600	1	20	1.0
BZX84C3V0	W3/Z13	3	2.8	3.2	95	5	600	1	10	1.0
BZX84C3V3	W4/Z14	3.3	3.1	3.5	95	5	600	1	5	1.0
BZX84C3V6	W5/Z15	3.6	3.4	3.8	90	5	600	1	5	1.0
BZX84C3V9	W6/Z16	3.9	3.7	4.1	90	5	600	1	3	1.0
BZX84C4V3	W7/Z17	4.3	4	4.6	90	5	600	1	3	1.0
BZX84C4V7	W8/Z1	4.7	4.4	5	80	5	500	1	3	2.0
BZX84C5V1	W9/Z2	5.1	4.8	5.4	60	5	480	1	2	2.0
BZX84C5V6	WA/Z3	5.6	5.2	6	40	5	400	1	1	2.0
BZX84C6V2	WB/Z4	6.2	5.8	6.6	10	5	150	1	3	4.0
BZX84C6V8	WC/Z5	6.8	6.4	7.2	15	5	80	1	2	4.0
BZX84C7V5	WD/Z6	7.5	7	7.9	15	5	80	1	1	5.0
BZX84C8V2	WE/Z7	8.2	7.7	8.7	15	5	80	1	0.7	5.0
BZX84C9V1	WF/Z8	9.1	8.5	9.6	15	5	100	1	0.5	6.0
BZX84C10	WG/Z9	10	9.4	10.6	20	5	150	1	0.2	7.0
BZX84C11	WH/Y1	11	10.4	11.6	20	5	150	1	0.1	8.0
BZX84C12	WI/Y2	12	11.4	12.7	25	5	150	1	0.1	8.0
BZX84C13	WK/Y3	13	12.4	14.1	30	5	170	1	0.1	8.0
BZX84C15	WL/Y4	15	13.8	15.6	30	5	200	1	0.1	10.5
BZX84C16	WM /Y5	16	15.3	17.1	40	5	200	1	0.1	11.2
BZX84C18	WN/Y6	18	16.8	19.1	45	5	225	1	0.1	12.6
BZX84C20	WO/Y7	20	18.8	21.2	55	5	225	1	0.1	14.0
BZX84C22	WP/Y8	22	20.8	23.3	55	5	250	1	0.1	15.4
BZX84C24	WR/Y9	24	22.8	25.6	70	5	250	1	0.1	16.8
BZX84C27	WS/Y10	27	25.1	28.9	80	2	300	1	0.1	18.9
BZX84C30	WT /Y11	30	28	32	80	2	300	1	0.1	21.0
BZX84C33	WU/Y12	33	31	35	80	2	325	1	0.1	23.1
BZX84C36	WW/Y13	36	34	38	90	2	350	1	0.1	25.2
BZX84C39	WX/Y14	39	37	41	130	2	350	1	0.1	27.3
BZX84C43	WY/Y15	43	40.85	45.15	150	5	375	1	0.1	30.10
BZX84C47	WZ/Y16	47	44.65	49.35	170	5	375	1	0.1	32.90
BZX84C51	XA/Y17	51	48.45	53.55	100	5	400	1	0.1	35.70

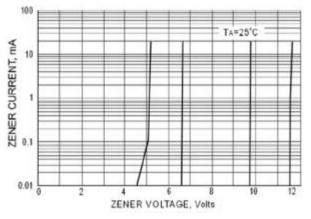
[•] China - Germany - Korea - Singapore - United States •

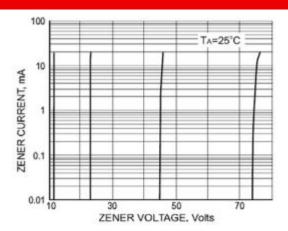
[•] http://www.smc-diodes.com - sales@ smc-diodes.com •



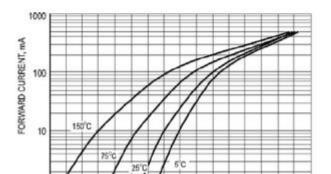


Ratings and Characteristics Curves

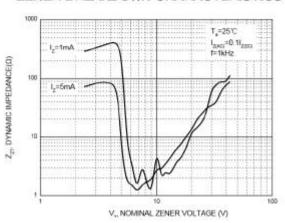




ZENER BREAKDOWN CHARACTERISTIC



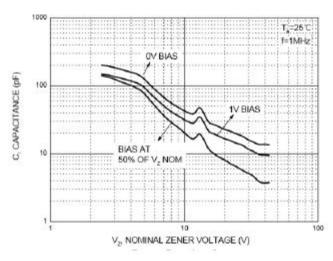
ZENER BREAKDOWN CHARACTERISTICS



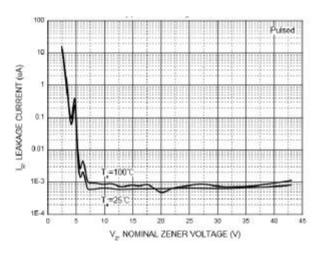
TYPICAL FORWARD VOLTAGE

FORWARD VOLTAGE, Volts

0.5



Effect of Zener Voltage on Zener Impedance



Typical Capacitance

Typical Leakage Current

• China - Germany - Korea - Singapore - United States •

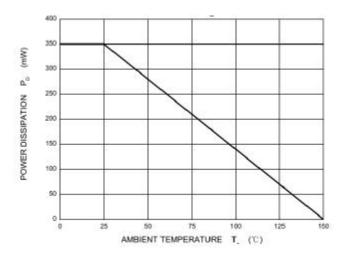
1.1

1.2

• http://www.smc-diodes.com - sales@ smc-diodes.com •







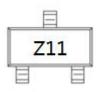
POWER DISSIPATION VS. AMBIENT TEMP

Ordering Information

Device	Package	Shipping		
BZX84C2V4- BZX84C51	SOT-23	3000pcs / reel		

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

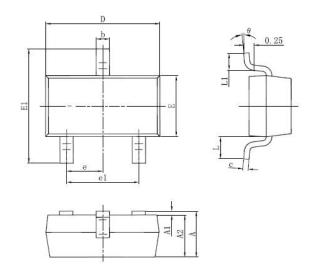
Marking Diagram



Z11 = Marking Code

Note: If date code is before 2016 year, please contact with factory about marking.

Mechanical Dimensions SOT-23



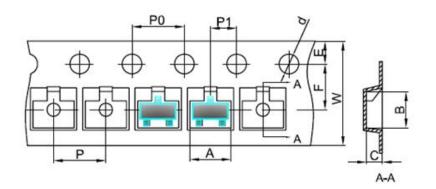
OVMDOL	Millin	neters	Inches		
SYMBOL	MIN.	MAX.	MIN.	MAX.	
Α	0.890	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.076	0.170	0.003	0.007	
D	2.650	3.050	0.104	0.120	
E	1.190	1.400	0.047	0.055	
E1	2.100	2.550	0.083	0.100	
е	0.950 TYP.		0.037 TYP.		
e1	1.780	2.050	0.070	0.081	
L	0.550 REF.		0.022 REF.		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com sales@ smc-diodes.com •





Carrier Tape Specification SOT-23



SYMBOL	Millimeters			
STWIBOL	Min.	Max.		
Α	3.05	3.25		
В	2.67	2.87		
С	1.12	1.32		
d	1.40	1.60		
E	1.65	1.85		
F	3.40	3.60		
Р	3.90	4.10		
P0	3.90	4.10		
P1	1.90	2.10		
W	7.90	8.30		

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